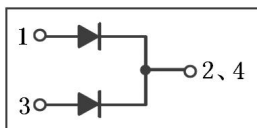


## / Descriptions

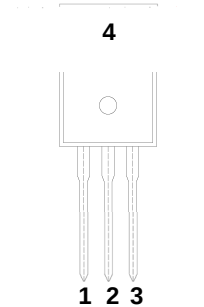
## / Features

## / Applications

## / Equivalent Circuit



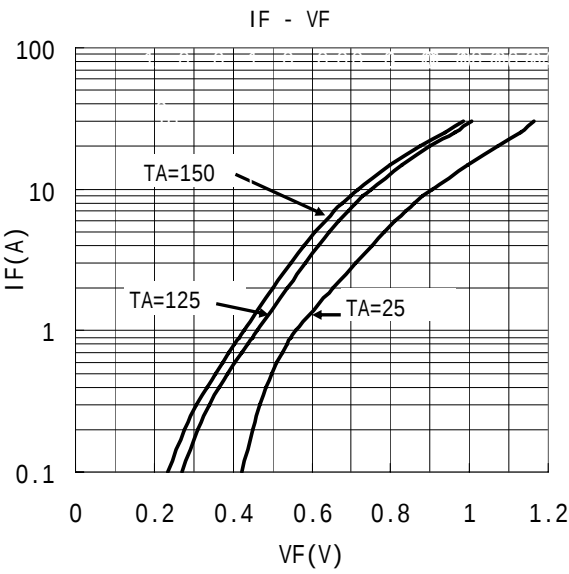
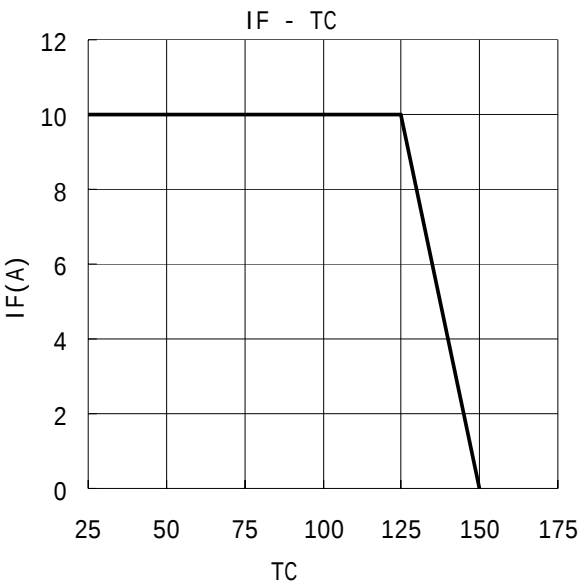
## / Pinning



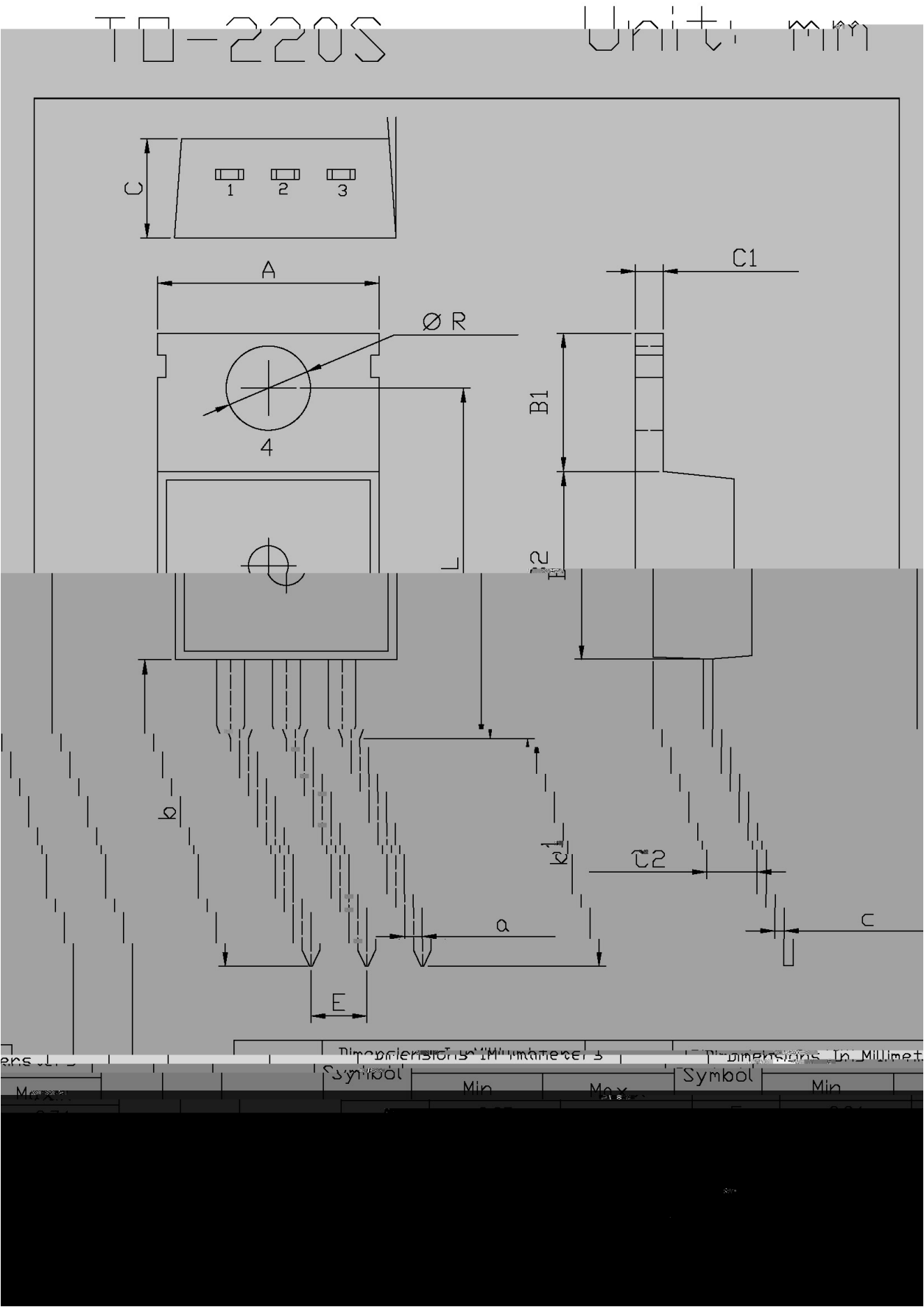
## / $h_{FE}$ Classifications & Marking

|  |  |  |  |
|--|--|--|--|
|  |  |  |  |
|  |  |  |  |
|  |  |  |  |

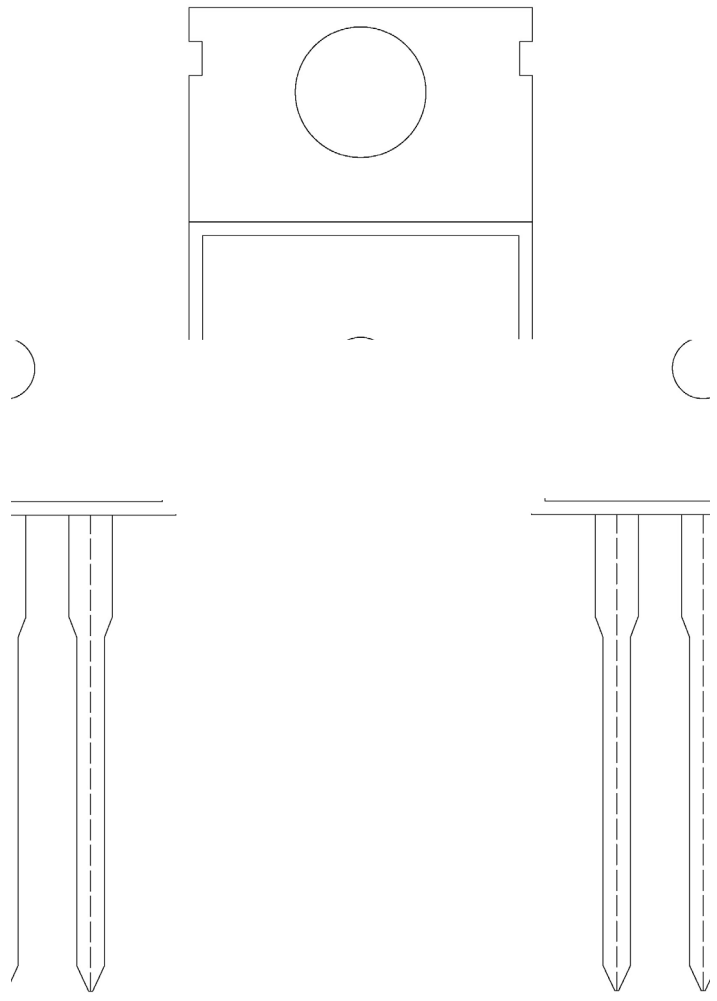
/ Electrical Characteristic Curve



/ Package Dimensions



/ Marking Instructions



(     ) / Temperature Profile for Dip Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

| 封装形式 | 包装数量 |      |     |     |     | 包装尺寸     : |   |   |
|------|------|------|-----|-----|-----|------------|---|---|
|      | 只 套管 | 套管 盒 | 只 盒 | 盒 箱 | 只 箱 | 套管         | 盒 | 箱 |
|      |      |      |     |     |     |            |   |   |

/ Notices